

Special Issue

Artificial Intelligence Chip and Advanced Integrated Circuit Design

Message from the Guest Editors

About 6th International Symposium on Computer, Consumer and Control (IS3C2023). This Special Issue pertains to the 6th International Symposium on Computer, Consumer and Control (IS3C2023) to be held in Taichung, Taiwan, June 30 - July 3, 2023. This conference offers a great opportunity for scientists, engineers, and practitioners to present the latest research results, ideas, developments, and applications. IS3C, held every two years, is hosted and sponsored by National Chin-Yi University of Technology, Taichung, Taiwan. Chips have a significant impact on people's livelihood, national defense, science and technology and other fields. Therefore, the United States, China, Japan, Germany and other major countries in the world have launched industrial competition. These events have repeatedly highlighted the importance of this industry. In this symposium, there is a chapter dedicated to this topic. So we would like to ask your journal for a special issue on chip design.

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Electronics is a multidisciplinary journal designed to appeal to a diverse audience of research scientists, practitioners, and developers in academia and industry. The journal is devoted to fast publication of latest technological breakthroughs, cutting-edge developments, and timely reviews of current and emerging technologies related to the broad field of electronics. Experimental and theoretical results are published as regular peer-reviewed articles or as articles within Special Issues guestedited by leading experts in selected topics of interest.

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